

## DECLARATION FOR PATENT APPLICATION

01S0606--1

As a below named inventor, I declare:  
that I verily believe myself to be the original, first and sole (if only one  
individual inventor is listed below) or an original, first and joint inventor  
(if more than one individual inventor is listed below) of the invention in

## SEMICONDUCTOR DEVICE

the specification of which is attached hereto unless the following box is  
checked.

☐ was filed on \_\_\_\_\_ as United States Application  
or PCT International Application No. \_\_\_\_\_, and  
was amended on \_\_\_\_\_ (if applicable).

I hereby state that I have reviewed and understand the contents of the above  
identified specification, including the claims, as amended by any amendment  
referred to above.

I acknowledge the duty to disclose information of which is material to pat-  
entability as defined in 37 CFR 1.56.

I hereby claim foreign priority benefits under 35 U.S.C. 119(a)-(d) or 365  
(b) of any foreign application(s) for patent or inventor's certificate, or  
35 U.S.C. 365(a) of any PCT International application which designated at  
least one country other than the United States, listed below and have also  
identified below any foreign application for patent or inventor's certifi-  
cate, or PCT International application having a filing date before that of the  
application on which priority is claimed:

<u>Country</u>	<u>Category</u>	<u>Application No.</u>	<u>Filing Date</u>	<u>Priority Claim</u>
Japan	Patent	2000-399297	December 27, 2000	Yes

I hereby appoint the registrants of Oblon, Spivak, McClelland,  
Maier & Neustadt, P.C., Fourth Floor, 1755 Jefferson Davis Highway,  
Arlington, Virginia 22202, Customer No. 22850, or any one of them.  
Send correspondence to Oblon, Spivak, McClelland, Maier & Neustadt,  
P.C., Fourth Floor, 1755 Jefferson Davis Highway, Arlington, Virginia  
22202, Telephone No. (703) 413-3000.

I declare further that all statements made herein of my own knowledge are  
true and that all statements made on information and belief are believed to  
be true; and further that these statements were made with the knowledge that  
willful false statements and the like so made are punishable by fine or im-  
prisonment, or both, under Section 1001 of Title 18 of the United States  
Code and that such willful false statements may jeopardize the validity of  
the application or any patent issued thereon.

## DECLARATION FOR PATENT APPLICATION

I declare further that my mailing address is at c/o  
Intellectual Property Division, KABUSHIKI KAISHA TOSHIBA, 1-1 Shibaura  
1-chome, Minato-ku, Tokyo 105-8001, Japan; and  
that my citizenship and residence are as stated below next to my name:

Inventor: (Signature)DateResidenceMotoshige KobayashiDate: DEC. 18.2001Citizen of: JapanHiratsuka-shi, JapanMotoshige KobayashiDate: DEC. 18.2001Citizen of: JapanKawasaki-shi, JapanHideki NozakiDate:Citizen of: JapanDate:Citizen of: JapanDate:Citizen of: JapanDate:Citizen of: JapanDate:Citizen of: JapanDate:Citizen of: Japan